CRMKTL15120A

N-Channel 150V, 103mΩ Typ. Power MOSFET

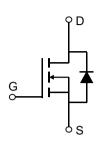
Description

Features

• 150V, 12A

 $R_{DS(ON)}$ Typ = $103m\Omega$ @ V_{GS} = 10VAdvanced Trench Technology

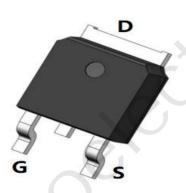
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

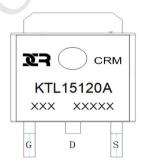




Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTL15120A	CRMKTL15120A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		150	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	12	Α
I _D	Continuous Drain Current	$T_{\rm C}$ = 100°C 7.2	7.2	Α
I _{DM}	Pulsed Drain Current (1)		48	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		4.4	mJ
P_{D}	Power Dissipation	T _C = 25°C	50	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		2.5	°C/W
T_{J}, T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 150V, V _{GS} = 0V	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Char	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.4	2	2.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 5A	-	103	134	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		- /	1305	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	62	-	pF
C_{rss}	Reverse Transfer Capacitance	I - IIVINZ	X -	50	-	pF
Q_g	Total Gate Charge	(16	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 75V, I_{D} = 5A$	<u></u>	3.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	v _{DS} = 73v, I _D = 3A	-	5	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	14	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 75V$	-	15	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 1A$, $R_{GEN} = 6\Omega$	-	25	-	ns
t_{f}	Turn-Off Fall Time		-	22	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	12	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	48	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 5A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I FA 11/11 (2001)	-	58	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 5A$, di/dt = 100A/us	_	100	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =4.2A

^{3.} Pulse Test: Pulse Width $\!\!\!\!<\!300\mu s,$ Duty Cycle $\!\!\!<\!0.5\%.$

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Test Circuit

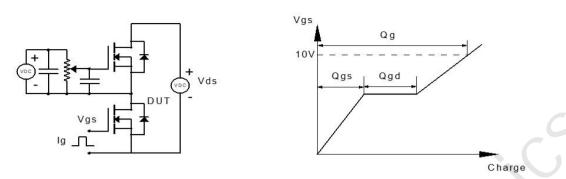


Figure 1: Gate Charge Test Circuit & Waveform

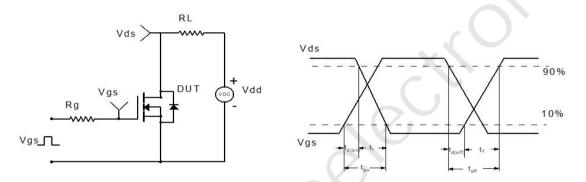


Figure 2: Resistive Switching Test Circuit & Waveform

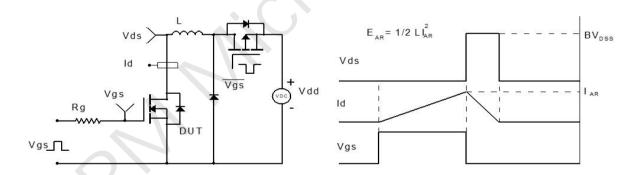


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

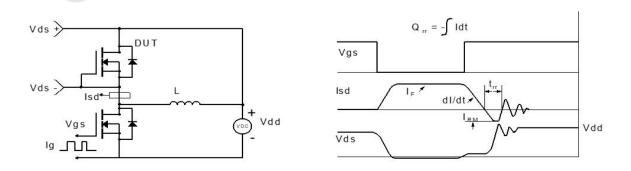
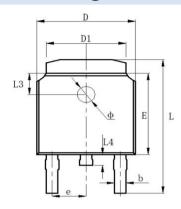


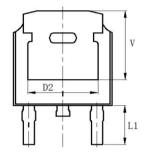
Figure 4: Diode Recovery Test Circuit & Waveform

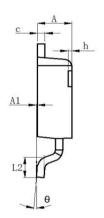
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Package Mechanical Data(TO-252-3L)







C b l	Dimensions In Millimeters			
Symbol	Min.	Max.		
Α	2.200	2.400		
A1	0.000	0.127		
b	0.600	0.860		
С	0.460	0.580		
D	6.500	6.700		
D1	5.100	5.460		
D2	4.830 REF.			
E	6.000	6.300		
е	2.186	2.386		
L	9.712	10.312		
_ L1	2.900 REF.			
L2	1.400	1.700		
L3	1.600 REF.			
L4	0.600	1.000		
Φ	1.100	1.300		
θ	0°	8°		
h	0.000	0.000 0.300		
V	5 250 REF			

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